

### Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise Noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage	30	V	
V <sub>GS</sub>	Gate to Source Voltage		±20	V
I <sub>D</sub>	Drain Current -Continuous	(Note 1a)	14	_
	-Pulsed		100	— A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	210	mJ
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	2.5	
		(Note 1b)	1.2	W
		(Note 1c)	1.0	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to +150	°C

# **Thermal Characteristics**

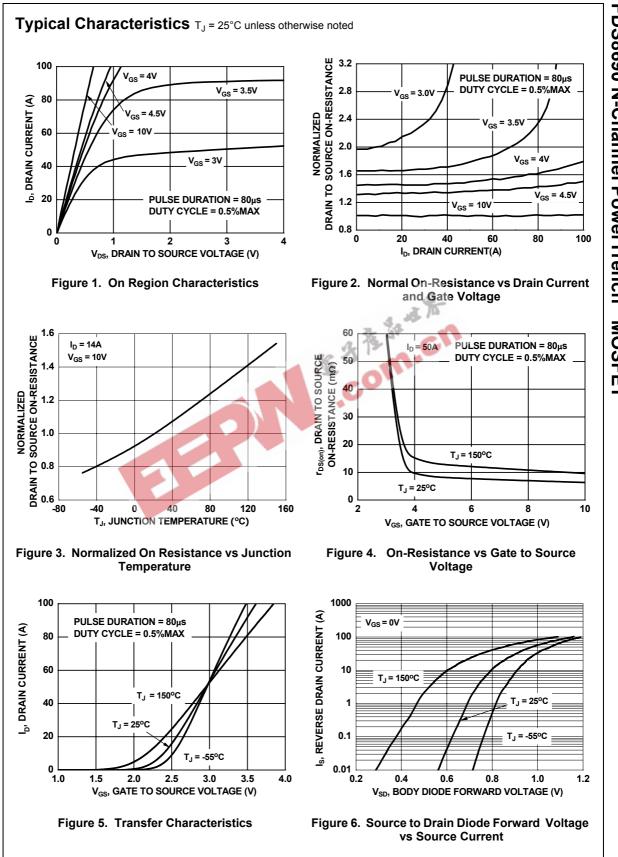
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W

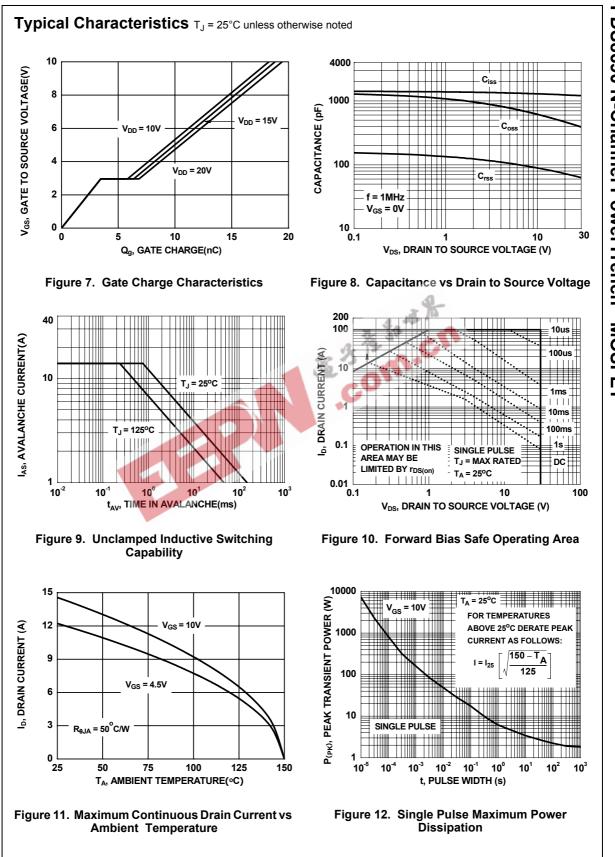
## Package Marking and Ordering Information

	Marking	Device	Reel Size	Tape Width	Quantity
FD	S8690	FDS8690	13"	12mm	2500 units

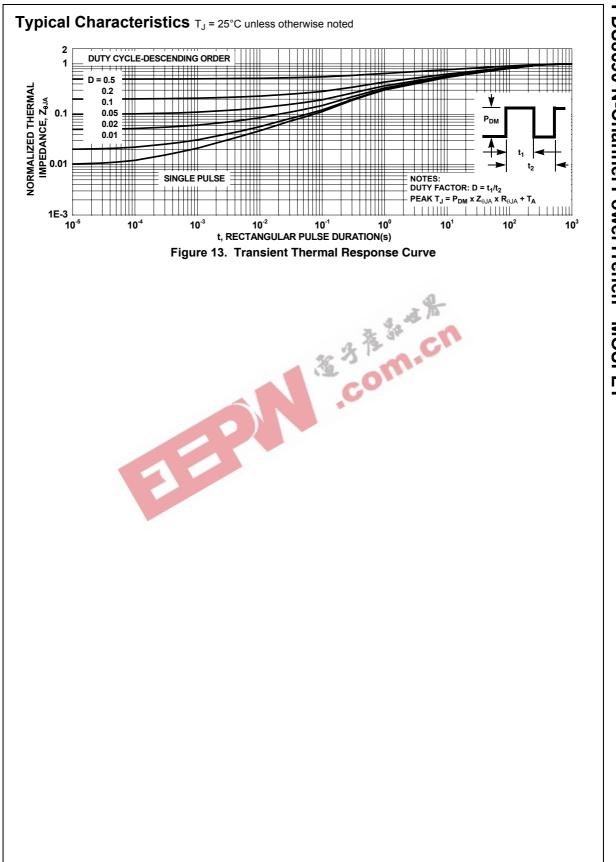
	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	30			V
ΔB <sub>VDSS</sub>	Breakdown Voltage Temperature	$I_D = 250 \mu A$ , referenced to		04.0		
$\Delta T_J$	Coefficient	25°C		34.3		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics (Note 2)					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	1.6	3	V
ΔV <sub>GS(th)</sub>	Gate to Source Threshold Voltage	I <sub>D</sub> =250µA, referenced to		4.5		
$\Delta T_J$	Temperature Coefficient	25°C		- 4.5		mV/°C
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 14A		6.3	7.6	
r <sub>DS(ON)</sub>	Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 11.5A		8.6	11.4	mΩ
DS(ON)		$V_{GS} = 10V, I_D = 14A,$ $T_J = 125^{\circ}C$		9.0	10.9	
Dynamic	Characteristics		St.			
C <sub>iss</sub>	Input Capacitance	W ARVIN BOUR		1260	1680	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1MHz	C	535	715	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			80	120	pF
R <sub>G</sub>	Gate Resistance	f = 1MHz		1.1		Ω
Switching	Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DS</sub> = 15V, I <sub>D</sub> = 1A,		8.0	16	ns
t <sub>r</sub>	Rise Time	$V_{GS} = 10V, R_{GS} = 6\Omega$		1.8	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	-		26 19	42 35	ns
t <sub>f</sub>	Fair Time	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V		19	35	ns
Qg	Total Gate Charge	$I_D = 14A$		18.8	27	nC
0	Total Gate Charge	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 5V		10	14	nC
Qg	Gate to Source Gate Charge	I <sub>D</sub> = 14A		3.5		nC
Q <sub>g</sub> Q <sub>gs</sub>	Osta ta Dusia Ohanna			2.9		nC
U U	Gate to Drain Charge					
Q <sub>gs</sub> Q <sub>gd</sub>	Irce Diode Characteristics					
Q <sub>gs</sub> Q <sub>gd</sub>	Ŭ	V <sub>GS</sub> = 0V, I <sub>S</sub> = 2.1A		0.7	1.2	V
Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	Irce Diode Characteristics	$V_{GS} = 0V, I_S = 2.1A$ $I_F = 14A, di/dt = 100A/\mu s$ $I_F = 14A, di/dt = 100A/\mu s$		0.7	1.2 45	V ns

2. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied. 3. Starting  $T_J = 25^{\circ}C$ , L = 3mH,  $I_{AS} = 11.8A$ ,  $V_{DD} = 24V$ ,  $V_{GS} = 10V$ .





FDS8690 N-Channel PowerTrench<sup>®</sup> MOSFET



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